



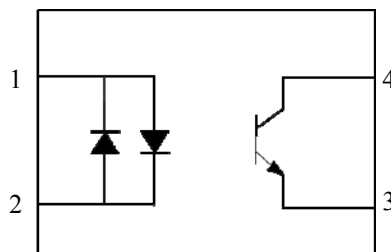
ISOCOM
COMPONENTS

IS280

DESCRIPTION

The IS280 is an optically coupled isolator consists of two infrared emitting diodes in reverse parallel connection and optically coupled to an NPN silicon photo transistor.

This device belongs to Isocom Compact Range of Optocouplers.



FEATURES

- Half Pitch 1.27mm
- High AC Isolation voltage 3750V_{RMS}
- Wide Operating Temperature Range -55°C to 100°C
- Pb Free and RoHS Compliant
- UL Approval E91231, Model AHP

APPLICATIONS

- Ring Detection on Telephone Lines
- Industrial System Controllers
- Measuring Instruments
- Signal Transmission between Systems of Different Potentials and Impedances

ORDER INFORMATION

- Available in Tape and Reel with 1000pcs per reel

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C)

Input Diode

Forward Current	±50mA
Peak Forward Current (10us)	1A
Power dissipation	70mW

Output Transistor

Collector to Emitter Voltage V _{CEO}	80V
Emitter to Collector Voltage V _{ECO}	6V
Power Dissipation	150mW

Total Package

Isolation Voltage	3750V _{RMS}
Total Power Dissipation	200mW
Operating Temperature	-55 to 100 °C
Storage Temperature	-55 to 125 °C
Lead Soldering Temperature (10s)	260°C

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IS280

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise specified)

INPUT

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Forward Voltage	V_F	$I_F = \pm 20\text{mA}$		1.2	1.4	V
Input Capacitance	C_{IN}	$V_F = 0\text{V}$, $f = 1\text{KHz}$		50	250	pF

OUTPUT

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Collector-Emitter Breakdown Voltage	BV_{CEO}	$I_C = 0.1\text{mA}$, $I_F = 0\text{mA}$	80			V
Emitter-Collector Breakdown Voltage	BV_{ECO}	$I_E = 0.01\text{mA}$, $I_F = 0\text{mA}$	6			V
Collector-Emitter Dark Current	I_{CEO}	$V_{CE} = 20\text{V}$, $I_F = 0\text{mA}$			100	nA

COUPLED

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Current Transfer Ratio	CTR	$I_F = \pm 1\text{mA}$, $V_{CE} = 5\text{V}$	20		300	%
CTR Symmetry		$I_F = \pm 1\text{mA}$, $V_{CE} = 5\text{V}$	0.5		2.0	
Collector—Emitter Saturation Voltage	$V_{CE(sat)}$	$I_F = \pm 20\text{mA}$, $I_C = 1\text{mA}$		0.1	0.2	V
Input to Output Isolation Voltage	V_{ISO}	See note 1	3750			V_{RMS}
Input to Output Isolation Resistance	R_{ISO}	$V_{IO} = 500\text{V}$ See note 1	5×10^{10}	1×10^{11}		Ω
Floating Capacitance	C_{IO}	$V_F = 0\text{V}$, $f = 1\text{MHz}$		0.6	1.0	pF
Output Rise Time	t_r	$V_{CE} = 2\text{V}$, $I_C = 2\text{mA}$, $R_L = 100\Omega$		6	18	μs
Output Fall Time	t_f			6	18	μs

Note 1 : Measured with input leads shorted together and output leads shorted together, R.H 40% to 60%

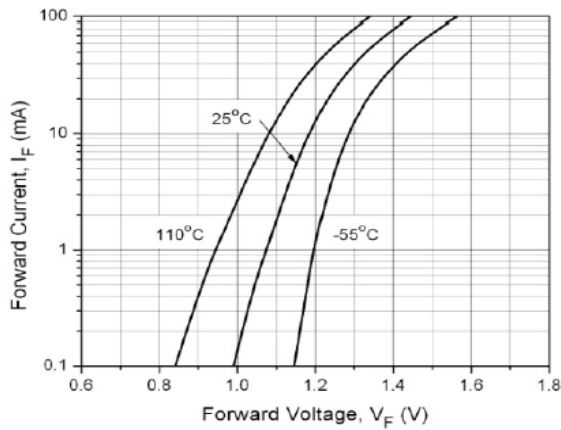


Fig 1 Forward Current vs Forward Voltage

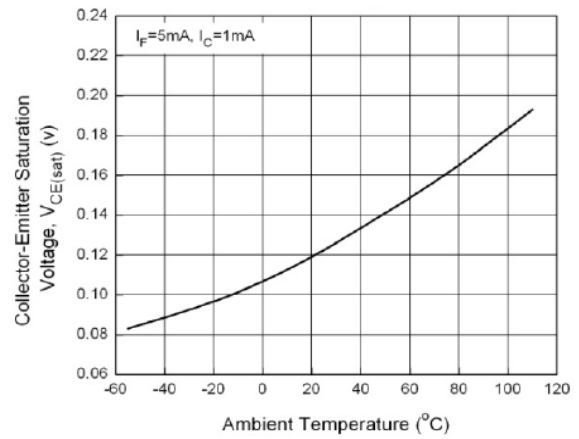


Fig 2 Collector-Emitter Saturation Voltage vs Ambient Temperature

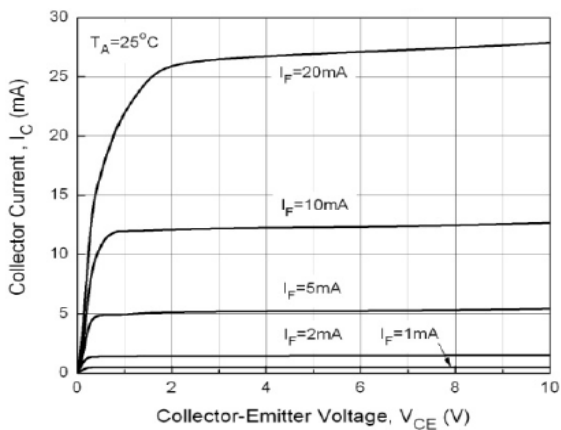


Fig 3 Collector Current vs Collector-Emitter Voltage (1)

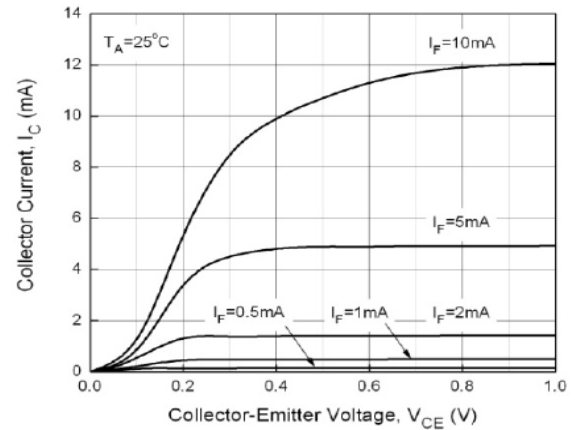


Fig 4 Collector Current vs Collector-Emitter Voltage (2)

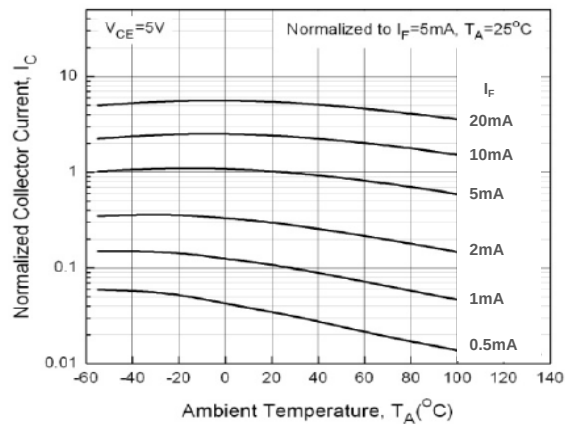


Fig 5 Normalized Collector Current vs Ambient Temperature

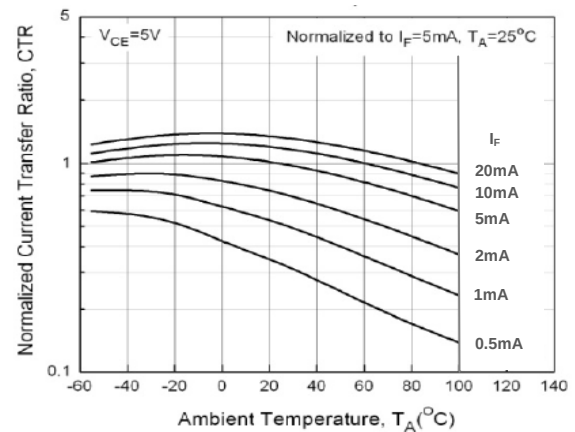


Fig 6 Normalized Current Transfer Ratio vs Ambient Temperature

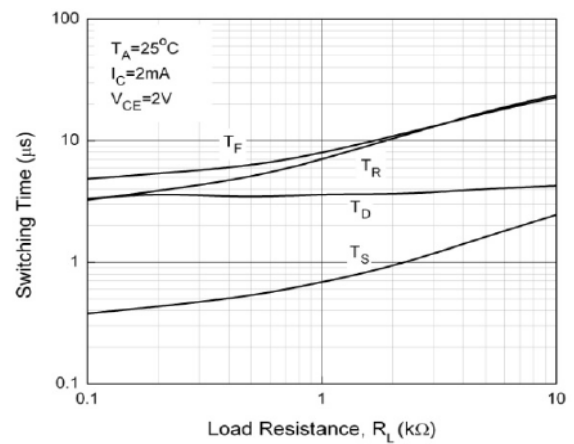
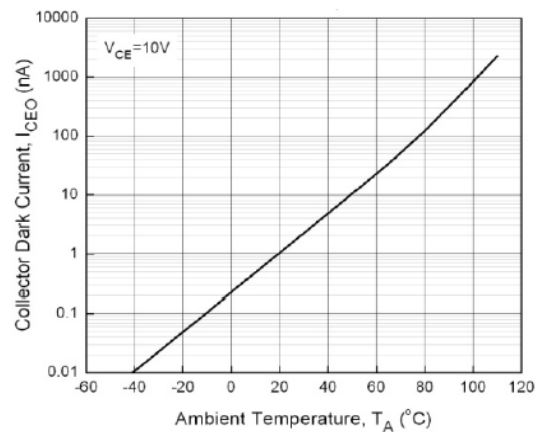
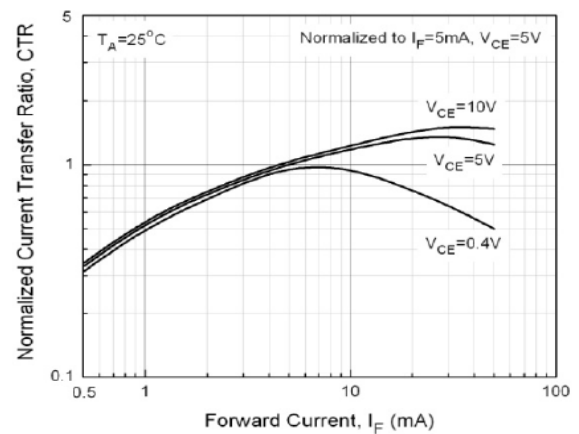
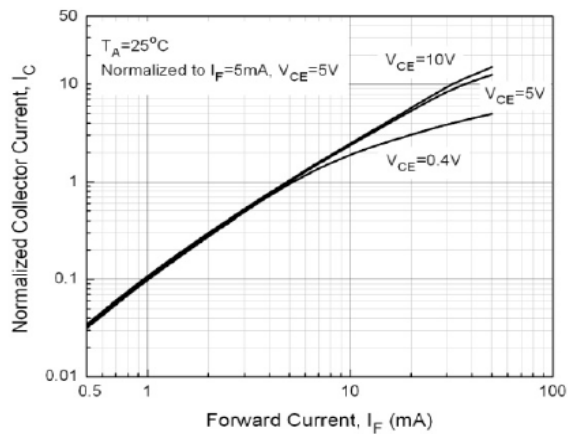
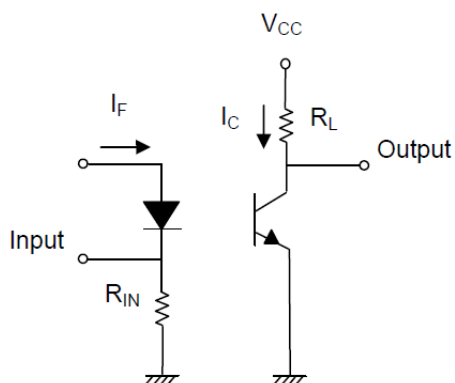
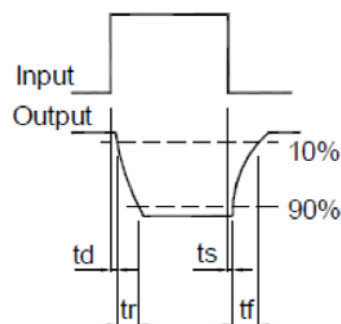


Fig 9 Collector Dark Current vs Ambient Temperature

Fig 10 Switching Time vs Load Resistance



Switching Time Test Circuit





ISOCOM
COMPONENTS

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ORDER INFORMATION

IS280			
After PN	PN	Description	Packing quantity
None	IS280	Surface Mount Tape & Reel	1000 pcs per reel

DEVICE MARKING

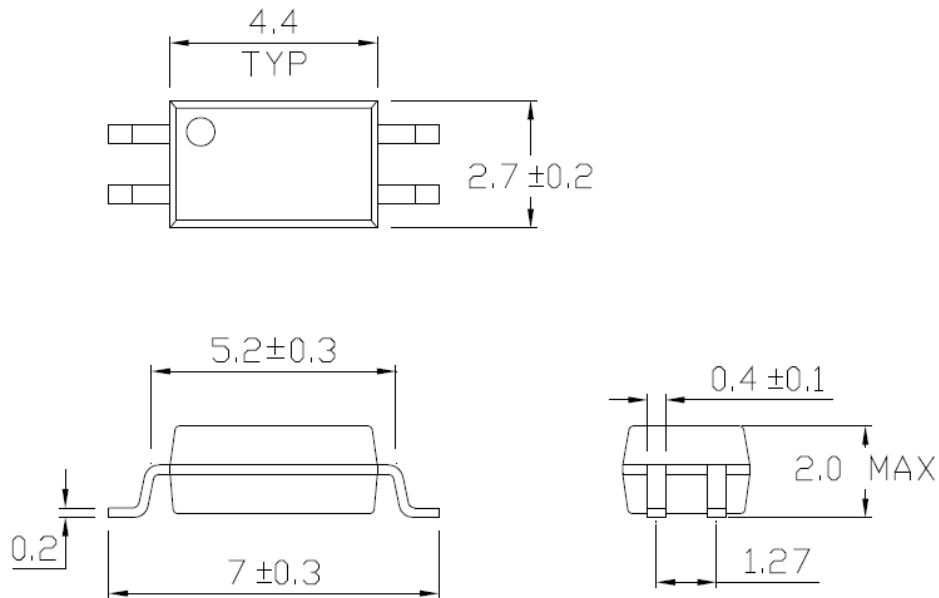


AHP1	denotes Device Part Number
I	denotes Isocom
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code

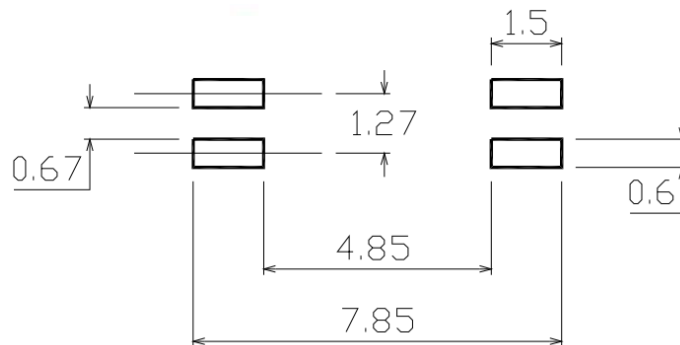


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PACKAGE DIMENSIONS (mm)

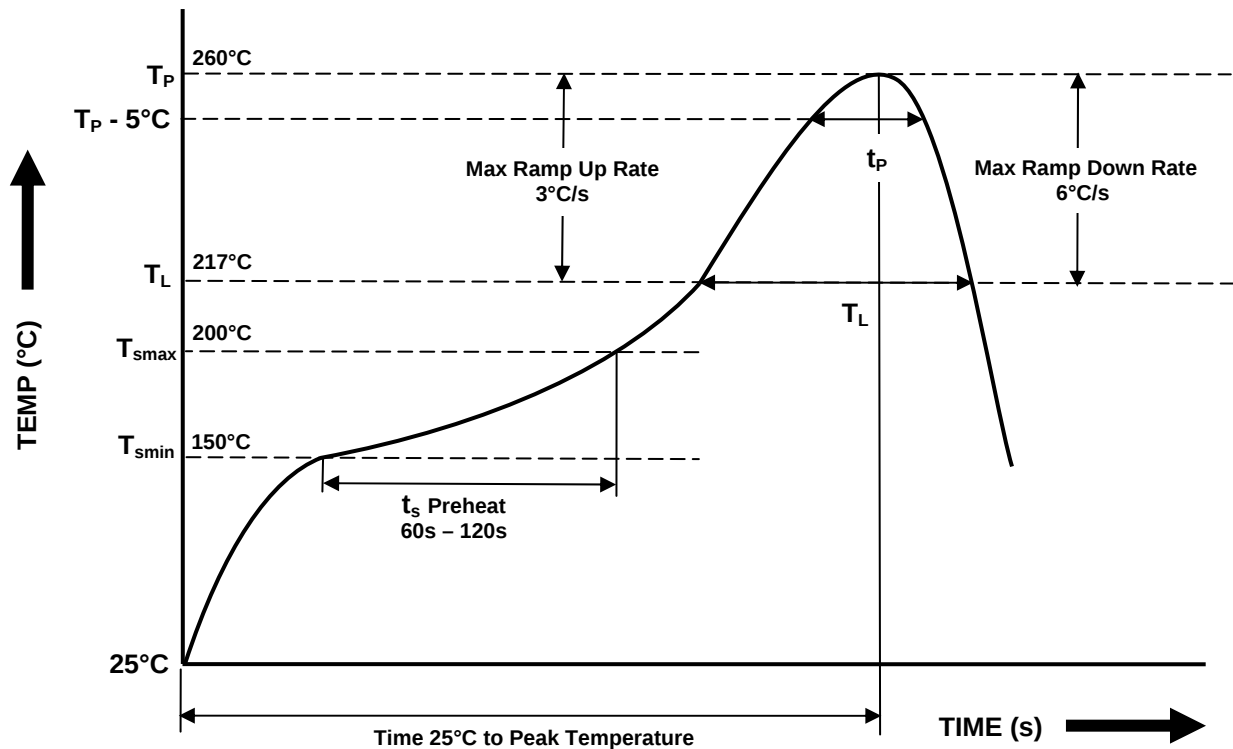


RECOMMENDED SOLDER PAD LAYOUT (mm)





IR REFLOW SOLDERING TEMPERATURE PROFILE
(One Time Reflow Soldering is Recommended)

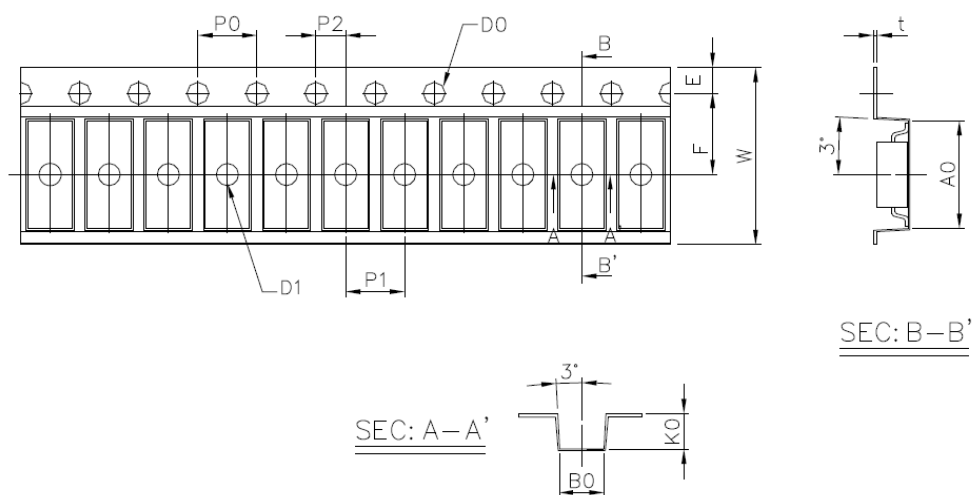


Profile Details	Conditions
Preheat - Min Temperature (T_{smin}) - Max Temperature (T_{smax}) - Time T_{smin} to T_{smax} (t_s)	150°C 200°C 60s - 120s
Soldering Zone - Peak Temperature (T_P) - Liquidous Temperature (T_L) - Time within 5°C of Actual Peak Temperature ($T_P - 5^\circ\text{C}$) - Time maintained above T_L (t_L) - Ramp Up Rate (T_L to T_P) - Ramp Down Rate (T_P to T_L)	260°C 217°C 30s 60s 3°C/s max 6°C/s max
Average Ramp Up Rate (T_{smax} to T_P)	3°C/s max
Time 25°C to Peak Temperature	8 minutes max



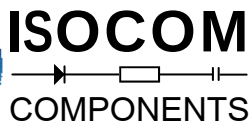
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TAPE AND REEL PACKAGING



Dimension No.	A	B	Do	D1	E	F
Dimension (mm)	3.0 ± 0.1	7.3 ± 0.1	$1.5 + 0.1/-0$	1.5 ± 0.1	1.75 ± 0.1	5.5 ± 0.1

Dimension No.	Po	P1	P2	t	W	K
Dimension (mm)	4.0 ± 0.15	4.0 ± 0.1	2.0 ± 0.1	0.25 ± 0.03	12.0 ± 0.2	2.4 ± 0.1



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- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/application where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc., please contact our sales representatives.
- When requiring a device for any "specific" application, please contact our sales for advice.
- The contents described herein are subject to change without prior notice.
- Do not immerse device body in solder paste.

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